

High Linearity Broadband SP2T 5MHz to 10GHz

Description

The F2972 is a single-pole double-throw (SP2T) reflective RF switch featuring high linearity and wide bandwidth. This device is optimized from 5MHz to 1.8GHz to support downstream cable modern future migration for DOCSIS 3.1 applications, and operates at up to 10GHz to support a multitude of wireless RF applications. Superb performance is achieved when used in either 50Ω or 75Ω terminating impedance applications.

The F2972 uses a single positive supply voltage of either +3.3V or +5.0V and is compatible with either 1.8V or 3.3V control logic.

Competitive Advantage

The F2972 provides extremely low insertion loss across the entire bandwidth while providing superb distortion performance.

- Optimized for DOCSIS 3.1 applications up to 1.8GHz
- Optimized for Wi-Fi applications up to 5.9GHz
- Low insertion loss
- High isolation
- Fast switching
- No external matching required

Typical Applications

- Broadband cable DOCSIS 3.0 / 3.1
- Set top box
- CATV filter bank switching
- Wi-Fi
- Cellular BTS
- General purpose

General Features

- Supply voltage: +2.5V to +5.25V
- 1.8V and 3.3V compatible control logic
- 2mm x 2mm, 12-pin TQFN package

Features (75 Ω)

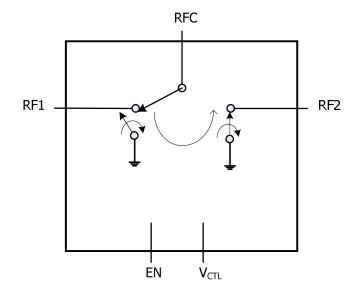
- Low insertion loss:
 - 0.23dB at 204MHz
 - 0.34dB at 1.8GHz
- High Isolation: 40dB at 1.8GHz
- P0.1dB compression of +37dBm at 204MHz
- Second Harmonic: -100dBc at 204MHz
- Third Harmonic: -120dBc at 204MHz
- Composite Second Order Distortion > 100dBc
- Composite Triple Beat Distortion > 100dBc

Features (50 Ω)

- Low insertion loss:
 - 0.40dB at 2.4GHz
 - 0.55dB at 8GHz
- High Isolation:
 - 34dB at 2.4GHz
- High Linearity:
 - IIP2 +125dBm at 2.4GHz
 - IIP3 +77dBm at 2.4GHz
- P0.1dB compression of +40dBm at 2.4GHz
- Second Harmonic: -100dBc at 2.4GHz
- Third Harmonic: -110dBc at 2.4GHz

Block Diagram

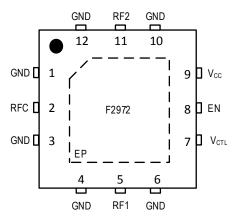
Figure 1. Block Diagram





Pin Assignments

Figure 2. Pin Assignments for 2mm x 2mm x 0.5mm 12-pin TQFN, NEG12 – Top View



Pin Descriptions

Table 1. Pin Descriptions

Table 1.	Pin Descript	lions
Number	Name	Description
1	GND	Internally grounded. Connect pin directly to paddle ground or as close as possible to pin with thru vias.
2	RFC	RF Common Port. If this pin is not 0V DC, then an external coupling capacitor must be used.
3	GND	Internally grounded. Connect pin directly to paddle ground or as close as possible to pin with thru vias.
4	GND	Internally grounded. Connect pin directly to paddle ground or as close as possible to pin with thru vias.
5	RF1	RF1 Port. If this pin is not 0V DC, then an external coupling capacitor must be used.
6	GND	Internally grounded. Connect pin directly to paddle ground or as close as possible to pin with thru vias.
7	V _{CTL}	Logic control pin.
8	EN	Active high enable pin. If low, neither RF1 nor RF2 are connected to RFC. Pin is internally pulled up to $2.5V$ through a $500k\Omega$ resistor.
9	V _{CC}	Power supply. Bypass to GND with capacitors shown in the Typical Application Circuit as close as possible to pin.
10	GND	Internally grounded. Connect pin directly to paddle ground or as close as possible to pin with thru vias.
11	RF2	RF2 Port. If this pin is not 0V DC, then an external coupling capacitor must be used.
12	GND	Internally grounded. Connect pin directly to paddle ground or as close as possible to pin with thru vias.
	EP	Exposed Pad. Internally connected to GND. Solder this exposed pad to a PCB pad that uses multiple ground vias to provide heat transfer out of the device into the PCB ground planes. These multiple ground vias are also required to achieve the specified RF performance.



Absolute Maximum Ratings

Stresses beyond those listed below may cause permanent damage to the device. Functional operation of the device at these or any other conditions beyond those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Table 2. Absolute Maximum Ratings

Par	ameter	Symbol	Minimum	Maximum	Units
V _{CC} to GND		Vcc	-0.3	+5.5	V
V _{CTL} , EN		V _{LOGIC}	-0.3	Lower of (V _{CC} + 0.3, 3.9)	V
RF1, RF2, RFC		V_{RF}	-0.3	+0.3	V
	$5MHz \le f_{RF} \le 10MHz$	P _{ABSCW1}		30	
Maximum Input CW	$10MHz < f_{RF} \le 25MHz$	P _{ABSCW2}		32	
Power, 50Ω , $T_{EP} = 25$ °C, $V_{CC} = 5.25V$ (any port,	$25MHz < f_{RF} \le 200MHz$	P _{ABSCW3}		33	dBm
insertion loss state) [a,b]	$200MHz < f_{RF} \le 6000MHz$	P _{ABSCW4}		34	
,	f _{RF} > 6000MHz	P _{ABSCW5}		33	
	$5MHz \le f_{RF} \le 10MHz$	P _{ABSPK1}		35	
Maximum Peak Power,	$10MHz < f_{RF} \le 25MHz$	P _{ABSPK2}		37	
50Ω , $T_{EP} = 25^{\circ}C$, $Vcc = 5.25V$ (any port,	$25MHz < f_{RF} \le 200MHz$	P _{ABSPK3}		38	dBm
insertion loss state) [a, b, c]	$200MHz < f_{RF} \le 6000MHz$	P _{ABSPK4}		39	
ŕ	f _{RF} > 6000MHz	P _{ABSPK5}		38	
Maximum Junction Temper	rature	T_{JMAX}		+140	°C
Storage Temperature Rang	ge	T _{ST}	-65	+150	°C
Lead Temperature (solderi	T _{LEAD}		+260	°C	
Electrostatic Discharge – F (JEDEC/ESDA JS-001-201	V _{ESDHBM}		2500 (Class 2)	V	
Electrostatic Discharge – C (JEDEC 22-C101F)	CDM	V _{ESDCDM}		1000 (Class C3)	V

a. In a 50Ω system, dBmV = dBm $[50\Omega]$ + 47. In a 75Ω system, dBmV = dBm $[75\Omega]$ + 48.75.

b. T_{EP} = Temperature of the exposed paddle.

c. 5% duty cycle of a 4.6ms period.



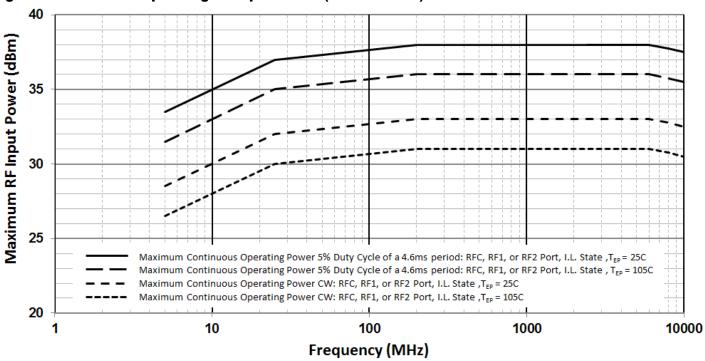
Recommended Operating Conditions

Table 3. Recommended Operating Conditions

Parameter	Symbol	Condition	Minimum	Typical	Maximum	Units
Supply Voltage	V _{CC}		2.5	3.3	5.25	V
Operating Temperature Range	T _{EP}	Exposed Paddle	-40		+105	°C
DE Fraguency Dongs	f	75Ω	0.005		1.8	GHz
RF Frequency Range	f_{RF}	50Ω	0.005		10	
Maximum Operating Input Power	P _{MAX}	Insertion Loss State $Z_S = Z_L = 50\Omega$			See Figure 3 [a]	dBm
Dort Impodence (DEC, DE1, DE2)	7	75Ω System		75		0
Port Impedance (RFC, RF1, RF2)	Z_{RF}	50Ω System		50		Ω

a. In a 50Ω system, dBmV = dBm $[50\Omega]$ + 47. In a 75Ω system, dBmV = dBm $[75\Omega]$ + 48.75.

Figure 3. Maximum Operating RF Input Power ($Z_s = Z_L = 50\Omega$)





General Specifications

Table 4. General Specifications

See F2972 Typical Application Circuit. Specifications apply when operated with V_{CC} = +3.3V, T_{EP} = +25°C, EN = HIGH, single tone signal applied at RF1 or RF2 and measured at RFC, unless otherwise noted.

Parameter	Symbol	Condition		Minimum	Typical	Maximum	Units
Logic Input High Threshold	V _{IH}	V _{CTL} , EN pins	V _{CTL} , EN pins			Lower of (V _{CC} , 3.6)	V
Logic Input Low Threshold	V_{IL}	V _{CTL} , EN pins		-0.3		0.6	V
Logic Current	I _{IH} , I _{IL}	V _{CTL} , EN pins (ea	ach pin)	-10 [a]		+10	μA
DC Current ()/	,	Normal Operatio	n		80	150	
DC Current (V _{CC})	I _{CC}	Standby (EN = LOW)			20	35	μA
Switching Rate	SW _{RATE}					25	kHz
Charles Time	т	From Standby State, 50% EN to 90% RF	No Change in RF Path		1.0		- µs
Startup Time	T _{STRTUP}		Change in RF Path		1.6		
Maximum Video Feed-Through, RFC Port	VID _{FT}	Peak transient during switching. $Z_S = Z_L = 75\Omega$. Measured with 20ns rise time, 0V to 3.3V (3.3V to 0V) control pulse applied to V_{CTL} .			5		mVp-p
Switching Time [c]	SW _{TIME}	50% V _{CTL} to 90%	or 10% RF		1.5	3	μs

a. Items in min/max columns in **bold italics** are guaranteed by test.

b. Items in min/max columns that are not bold italics are guaranteed by design characterization.

c. Measured at $f_{RF} = 1GHz$.



Electrical Characteristics

Table 5. Electrical Characteristics - 75Ω SPECIFICATION

See F2972 75 Ω Application Circuit. Specifications apply when operated with V_{CC} = +3.3V, T_{EP} = +25°C. Z_S = Z_L = 75 Ω , EN = HIGH, single tone signal applied at RF1 or RF2 and measured at RFC, EVKit trace and connector losses are de-embedded, unless otherwise noted.

Parameter	Symbol	Condition	Minimum	Typical	Maximum	Units	
		f _{RF} = 5MHz		0.20			
		5MHz < f _{RF} ≤ 204MHz		0.23	0.43 [b]	٩D	
Insertion Loss (RFC to RF1, RF2)	IL	204MHz < f _{RF} ≤ 1.2GHz		0.32	0.52	dB	
		1.2GHz < f _{RF} ≤ 1.8GHz		0.34	0.54		
		f _{RF} = 5MHz		77			
Isolation (All Paths)	ISO1	$5MHz < f_{RF} \le 204MHz$		60		dB	
Isolation (All Paths)	1301	$204MHz < f_{RF} \le 1.2GHz$		44		ub ub	
		$1.2GHz < f_{RF} \le 1.8GHz$		40			
		f _{RF} = 5MHz		35			
Return Loss (RFC, RF1, RF2)	RL	$5MHz < f_{RF} \le 204MHz$		30		dB	
(Insertion Loss States)		$204MHz < F_{RF} \le 1.2GHz$		17			
		$1.2GHz < F_{RF} \le 1.8GHz$		16			
		f _{IN} = 27MHz P _{OUT} = 20dBm [c]		-80	-70		
2 nd Harmonic	H2	$f_{IN} = 204MHz P_{OUT} = 20dBm$		-100	-90	dBc	
		$f_{IN} = 800MHz P_{OUT} = 20dBm$		-120	-110		
		f_{IN} = 17MHz P_{OUT} = 20dBm		-95	-80		
3 rd Harmonic	Н3	$f_{IN} = 204MHz P_{OUT} = 20dBm$		-120	-105	dBc	
		$f_{IN} = 800MHz P_{OUT} = 20dBm$		-115	-100		
		f _{RF} = 5MHz		37			
Input 0.1dB Compression Point [4] (RFC to RF1, RF2)	P0.1dB	f _{RF} =204MHz		37		dBm	
[f _{RF} =1.8GHz		38			
Composite Second Order	CSO	41 dBmV / channel		>100		- dBc	
Composite Triple Beat	CTB	137 channels [e]		>100		ubc	

- a. Items in min/max columns in **bold italics** are guaranteed by test.
- b. Items in min/max columns that are not bold italics are guaranteed by design characterization.
- c. $dBmV = dBm [75\Omega] + 48.75$.
- d. The input 0.1dB compression point is a linearity figure of merit. Refer to Figure 3 for the maximum operating RF input power levels.
- e. Total power = -7.75dBm [75Ω] + $10*\log(137)$ = +13.62dBm [75Ω].



Electrical Characteristics

Table 6. Electrical Characteristics - 50Ω SPECIFICATION

See F2972 50 Ω Application Circuit. Specifications apply when operated with V_{CC} = +3.3V, T_{EP} = +25°C. Z_S = Z_L = 50 Ω , EN = HIGH, single tone signal applied at RF1 or RF2 and measured at RFC, EVKit trace and connector losses are de-embedded, unless otherwise noted.

Parameter	Symbol	Condition	Minimum	Typical	Maximum	Units
		f _{RF} = 5MHz		0.25	0.45 [b]	
		5MHz < f _{RF} ≤ 1GHz		0.33	0.53	
		1GHz < f _{RF} ≤ 2GHz [c]		0.36	0.56 ^[a]	
Insertion Loss		2GHz < f _{RF} ≤ 3GHz		0.40		-10
(RFC to RF1, RF2)	IL	3GHz < f _{RF} ≤ 6GHz		0.45		dB
		6GHz < f _{RF} ≤ 8GHz		0.55		
		8GHz < f _{RF} ≤ 9GHz		0.65		
		9GHz < f _{RF} ≤ 10GHz		0.80		
		5MHz < f _{RF} ≤ 1GHz	43	48		
		1GHz < f _{RF} ≤ 2GHz	36	42		
Isolation	1004	2GHz < f _{RF} ≤ 3GHz	31	37		- dB -
(RFC to RF1, RF2)	ISO1	3GHz < f _{RF} ≤ 6GHz		27		
		6GHz < f _{RF} ≤ 8GHz		22		
		8GHz < f _{RF} ≤ 10GHz		18		
		$5MHz < f_{RF} \le 1GHz$	40	45		
		$1GHz < f_{RF} \le 2GHz$	33	38		
Isolation	ISO2	2GHz < f _{RF} ≤ 3GHz	29	34		dB
(RF1 to RF2, RF2 to RF1)	1302	$3GHz < f_{RF} \le 6GHz$		26		uБ
		$6GHz < f_{RF} \le 8GHz$		21		
		$8GHz < f_{RF} \le 10GHz$		18		
		$5MHz < f_{RF} \le 1GHz$		28		
		$1GHz < f_{RF} \le 2GHz$		26		
Deturn Less (DEC. DE1, DE2)		2GHz < f _{RF} ≤ 3GHz		26		
Return Loss (RFC, RF1, RF2) (Insertion loss states)	RL	$3GHz < f_{RF} \le 6GHz$		25		dB
		6GHz < f _{RF} ≤ 8GHz		23		
		8GHz < f _{RF} ≤ 9GHz		18		
		$9GHz < f_{RF} \le 10GHz$		16		

a. Items in min/max columns in bold italics are guaranteed by test.

b. Items in min/max columns that are not bold italics are guaranteed by design characterization.

c. Minimum or maximum specification guaranteed by test at 2GHz and by design characterization over the whole frequency range.



Electrical Characteristics

Table 7. Electrical Characteristics - 50Ω SPECIFICATION

See F2972 50 Ω Application Circuit. Specifications apply when operated with V_{CC} = +3.3V, T_{EP} = +25°C. Z_S = Z_L = 50 Ω , EN = HIGH, single tone signal applied at RF1 or RF2 and measured at RFC, EVKit trace and connector losses are de-embedded, unless otherwise noted.

Parameter	Symbol	Condition	Minimum	Typical	Maximum	Units	
		f _{RF} = 2.4GHz		40			
Input 0.1dB Compression [6]	P0.1dB	$f_{RF} = 6.0GHz$		40		dBm	
		$f_{RF} = 8.0GHz$		40			
Input IP3 (RF1, RF2 to RFC)				77		dBm	
Input IP2	IIP2	f_1 = 700MHz f_2 = 1.7GHz P_{IN} = +24dBm/tone Measure 2.4GHz product		125		dDas	
(RF1, RF2 to RFC)	IIPZ	$f_1 = 2.4 GHz$ $f_2 = 3.5 GHz$ $P_{IN} = +24 dBm/tone$ Measure 5.9 GHz product		120		- dBm	
Second Harmonic	H2	f _{IN} = 2.4GHz, P _{IN} = +24dBm		-100	-90 [b]	-ID-	
(RF1, RF2 to RFC)	ПΖ	$f_{IN} = 5.9GHz, P_{IN} = +24dBm$		-90	-80	dBc	
Third Harmonic	Н3	f _{IN} = 2.4GHz, P _{IN} = +24dBm		-110	-95	dDo	
(RF1, RF2 to RFC)	пэ	f _{IN} = 5.9GHz, P _{IN} = +24dBm		-100	-85	dBc	
Spurious Output	P _{SPUR1}	f _{OUT} ≥ 5MHz All unused ports terminated		-133		dBm	
(No RF Applied)	P _{SPUR2}	f _{OUT} < 5MHz All unused ports terminated		-120		UDIII	

a. Items in min/max columns in **bold italics** are guaranteed by test.

b. Items in min/max columns that are not bold italics are guaranteed by design characterization.

c. The input 0.1dB compression point is a linearity figure of merit. Refer to Figure 3 for the maximum RF operating input power levels.



Thermal Characteristics

Table 8. Package Thermal Characteristics

Parameter	Symbol	Value	Units
Junction to Ambient Thermal Resistance	θ_{JA}	102	°C/W
Junction to Case Thermal Resistance (Case is defined as the exposed paddle)	θјс_вот	56	°C/W
Moisture Sensitivity Rating (Per J-STD-020)		MSL 1	

Typical Operating Conditions (TOCs)

Unless otherwise noted:

- V_{CC} = +3.3V
- EN = HIGH
- $Z_L = Z_S = 75\Omega$
- $Z_L = Z_S = 50\Omega$
- All temperatures are referenced to the exposed paddle
- Evaluation Kit traces and connector losses are de-embedded

Typical Performance Characteristics - 75Ω Performance

Figure 4. RF1 to RFC Insertion Loss

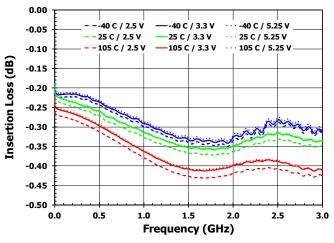


Figure 6. RF1 to RFC Isolation [RF2 On State]

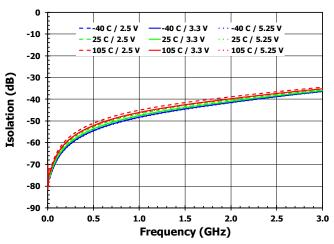


Figure 8. RF1 to RF2 Isolation [RF1 On State]

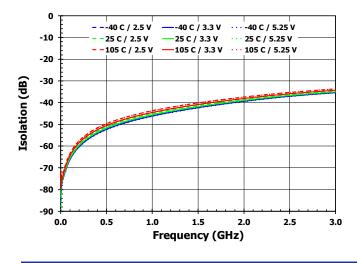


Figure 5. RF2 to RFC Insertion Loss

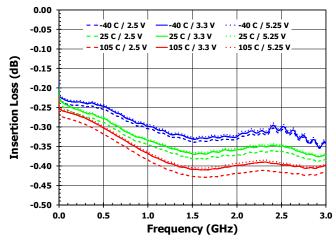


Figure 7. RF2 to RFC Isolation [RF1 On State]

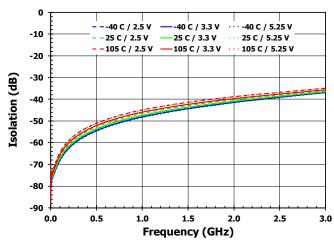
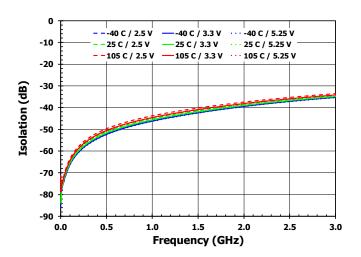


Figure 9. RF1 to RF2 Isolation [RF2 On State]





Typical Performance Characteristics - 75Ω Performance

Figure 10. RFC Return Loss [RF1 On State]

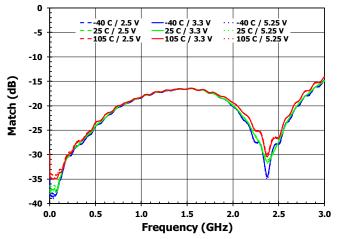


Figure 12. RF1 Return Loss [RF1 On State]

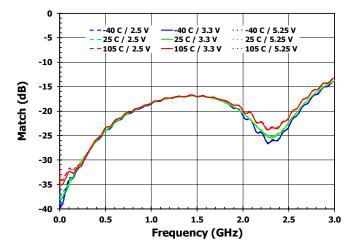


Figure 11. RFC Return Loss [RF2 On State]

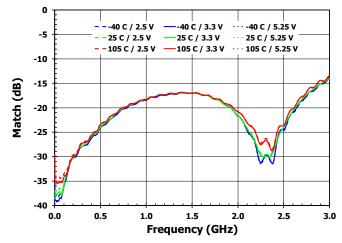
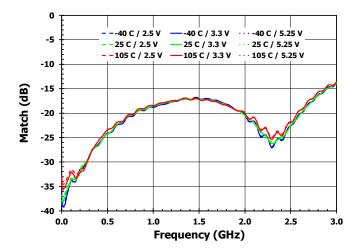


Figure 13. RF2 Return Loss [RF2 On State]



Typical Performance Characteristics - 50Ω Performance

Figure 14. RF1 to RFC Insertion Loss

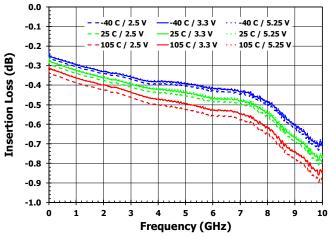


Figure 16. RF1 to RFC Isolation [RF2 On State]

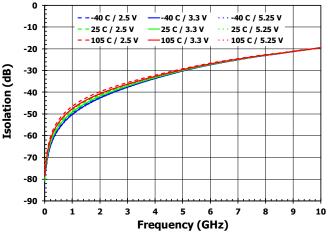


Figure 18. RF1 to RF2 Isolation [RF1 On State]

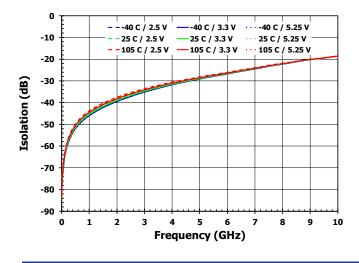


Figure 15. RF2 to RFC Insertion Loss

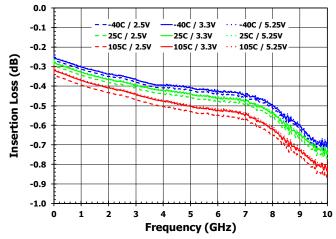


Figure 17. RF2 to RFC Isolation [RF1 On State]

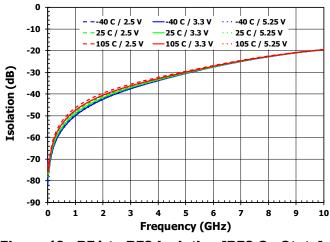
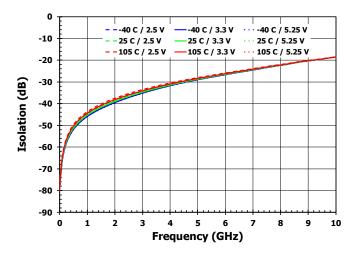


Figure 19. RF1 to RF2 Isolation [RF2 On State]



Typical Performance Characteristics - 50Ω Performance

Figure 20. RFC Return Loss [RF1 On State]

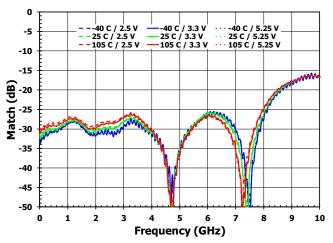


Figure 22. RF1 Return Loss [RF1 On State]

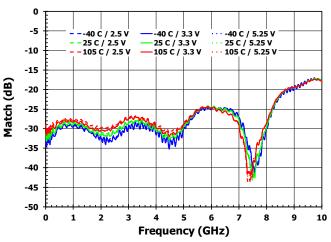


Figure 24. Switching Time [Isolation to Insertion Loss State]

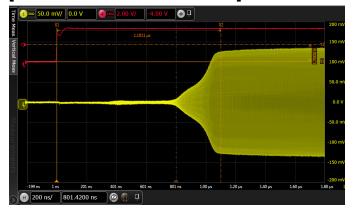


Figure 21. RFC Return Loss [RF2 On State]

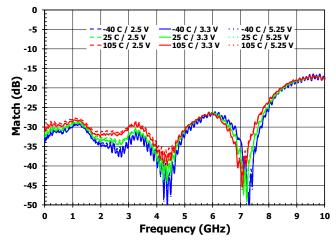


Figure 23. RF2 Return Loss [RF2 On State]

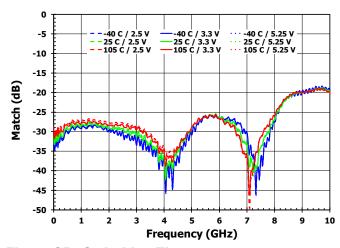
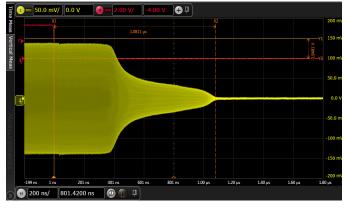


Figure 25. Switching Time [Insertion Loss to Isolation State]





Control Mode

Table 9. Switch Control Truth Table

V _{CTL} (pin 7)	EN (pin 8)	Switch State	
LOW	HIGH	RFC to RF1 Insertion Loss State	
HIGH	HIGH	RFC to RF2 Insertion Loss State	
Don't Care	LOW	Standby	

Application Information

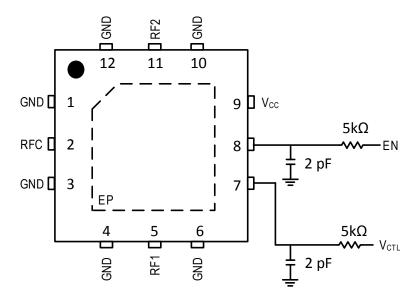
Power Supplies

A common V_{CC} power supply should be used for all pins requiring DC power. All supply pins should be bypassed with external capacitors to minimize noise and fast transients. Supply noise can degrade noise figure and fast transients can trigger ESD clamps and cause them to fail. Supply voltage change or transients should have a slew rate smaller than $1V / 20\mu s$. In addition, all control pins should remain at 0V (+/-0.3V) while the supply voltage ramps up or while it returns to zero.

Control Pin Interface

If control signal integrity is a concern and clean signals cannot be guaranteed due to overshoot, undershoot, ringing, etc., the following circuit at the input of each control pin is recommended. This applies to control pins 7 and 8 as shown below.

Figure 26. Control Pin Interface Schematic





75 Ω Evaluation Kit Picture

Figure 27. Top View (75 Ω)

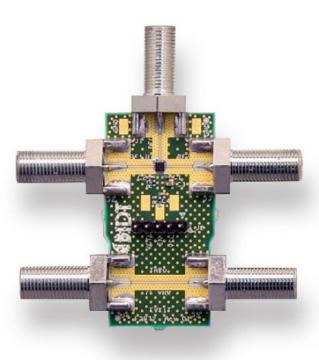
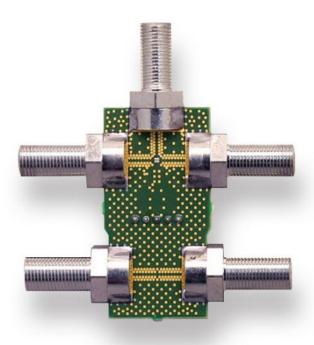


Figure 28. Bottom View (75 Ω)





50Ω Evaluation Kit Picture

Figure 29. Top View (50 Ω)



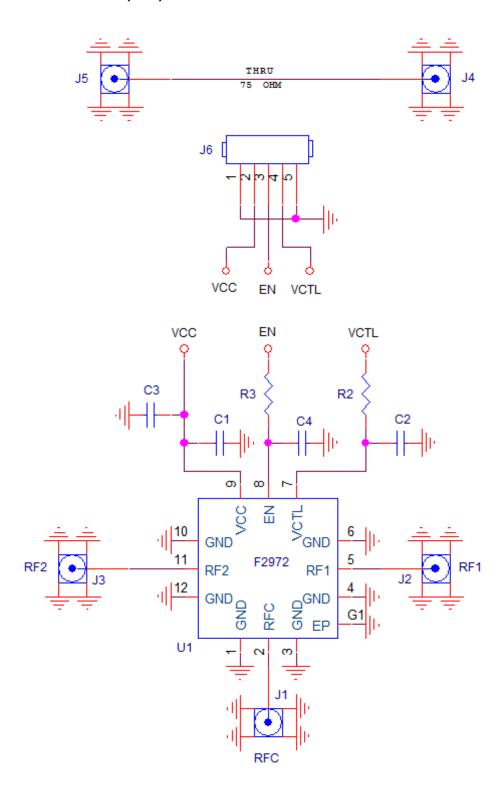
Figure 30. Bottom View (50 Ω)





75Ω Evaluation Kit / Applications Circuit

Figure 31. Electrical Schematic (75 Ω)





50Ω Evaluation Kit / Applications Circuit

Figure 32. Electrical Schematic (50 Ω)

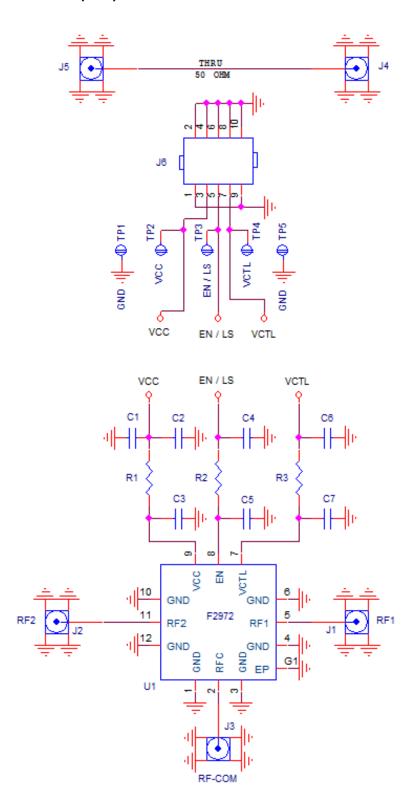




Table 10. 75Ω Bill of Material (BOM)

Part Reference	QTY	Description	Manufacturer Part #	Manufacturer
C1	1	0.1µF ±10%, 16V, X7R, Ceramic Capacitor (0402)	GRM155R71C104KA88D	Murata
C2, C4	2	100pF ±5% 50V, C0G, Ceramic Capacitor (0402)	GRM1555C1H101JA01D	Murata
C3	1	0.01µF ±5% 50V, X7R, Ceramic Capacitor (0603)	GRM188R71H103JA01D	Murata
R2, R3	2	100Ω 1/10W, Resistor (0402)	ERJ-2RKF1000X	Panasonic
J1 – J5	5	F-Type Edge Mount	222181	Amphenol RF
J6	1	Conn Header Vert 5x1 Pos Gold	68002-205HLF	Amphenol FCI
U1	1	SP2T Switch 2mm x 2mm 12-pin TQFN	F2972NEGK	IDT
	1	Printed Circuit Board	F2972 75Ω PCB	IDT

Table 11. 50Ω Bill of Material (BOM)

Part Reference	QTY	Description	Manufacturer Part #	Manufacturer
C1 – C7	0	Not Installed (0402)		
R1– R3	3	0Ω 1/10W, Resistor (0402)	ERJ-2GE0R00X	Panasonic
J1 – J5	5	SMA Edge Mount	142-0761-881	Cinch Connectivity
J6	1	Conn Header 10 Pos 0.100" Str 15 Au	68602-210HLF	Amphenol FCI
TP1, TP2, TP3, TP4, TP5	0	Not Installed Test Point Loop		
U1	1	SP2T Switch 2mm x 2mm 12-pin TQFN	F2972NEGK	IDT
	1	Printed Circuit Board	F2972 50Ω PCB	IDT



Evaluation Kit (EVKit) Operation

External Supply Setup

Set up a V_{CC} power supply in the voltage range of 2.5V to 5.25V with the power supply output disabled.

For the 75 Ω EVKit, connect the disabled Vcc supply connection to J6 pin 2 and GND to J6 pins 1 or 5.

For the 50Ω EVKit, connect the disabled Vcc supply connection to J6 pin 3 and GND to J6 pin 1, 2, 4, 6, 8, 9, or 10.

Logic Control Setup

With the logic control lines disabled set the HIGH and LOW logic levels to satisfy the levels stated in the electrical specifications table.

For the 75 Ω EVKit, connect the disabled logic control lines to J6 EN (pin 3) and V_{CTL} (pin 4).

For the 50Ω EVKit, connect the disabled logic control lines to J6 EN / LS (pin 5) and V_{CTL} (pin 7).

See Table 9 for the logic truth table.

Turn On Procedure

Setup the supplies and EVKit as noted in the External Supply Setup and Logic Control Setup sections above.

Enable the V_{CC} supply.

Enable the logic control signals.

Set the logic setting to achieve the desired Table 9 configuration. Note that external control logic should not be applied without V_{CC} being present.

Turn Off Procedure

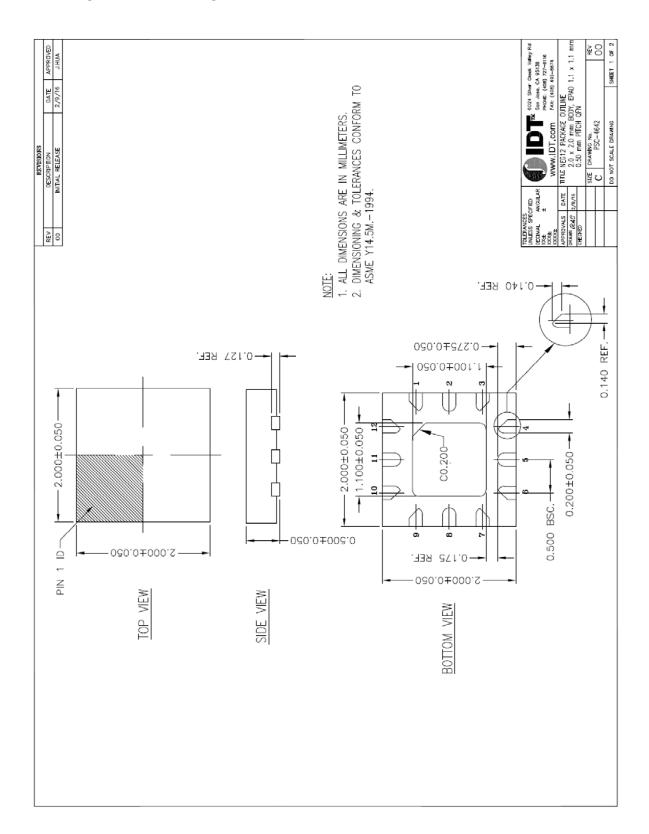
Set the logic control pins to a logic LOW.

Disable the V_{CC} supply.



Package Drawings

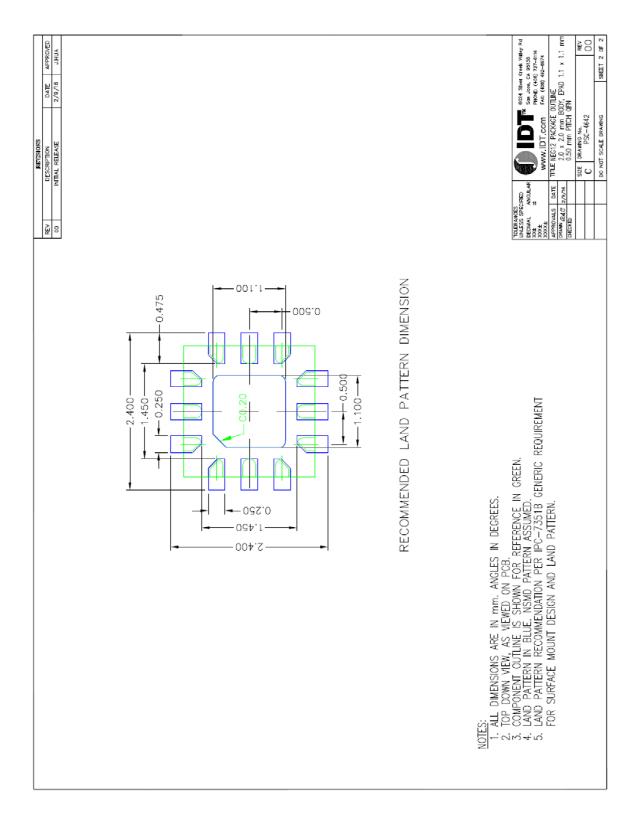
Figure 33. Package Outline Drawing NEG12 PSC-4642





Recommended Land Pattern

Figure 34. Recommended Land Pattern NEG12 PSC-4642





Marking Diagram

2972 YW**

Line 1 - 2972 = Abbreviated part number.

Line 2 - Y = Year code.

Line 2 - W = Work week code.

Line 2 - ** = Sequential alpha for lot traceability.

Ordering Information

Orderable Part Number	Package	MSL Rating	Shipping Packaging	Temperature
F2972NEGK	2mm x 2mm x 0.5mm 12-VFQFP-N	MSL1	Cut Reel	-40°C to +105°C
F2972NEGK8	2mm x 2mm x 0.5mm 12-VFQFP-N	MSL1	Tape and Reel	-40°C to +105°C
F2972EVBI-75OHM	75Ω Evaluation Board			
F2972EVBI-50OHM	50Ω Evaluation Board			



Revision History

Revision	Revision Date	Description of Change
Rev O	2017-Apr-19	Initial Release

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